

## Electronic Patent Application Fee Transmittal

Application Number:	10788700			
Filing Date:	27-Feb-2004			
Title of Invention:	Full-wafer or large area imprinting with multiple separated sub-fields for high throughput lithography			
First Named Inventor/Applicant Name:	Sidlgata V. Sreenivasan			
Filer:	Kelly K. Kordzik/Danielle Chandler			
Attorney Docket Number:	P107/MII-72-54-03			
Filed as Small Entity				
<b>Utility Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
Claims in excess of 20	2202	3	25	75
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>75</b>